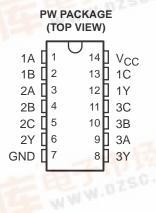
## 捷多邦,专业PCB打样工厂,24小时加急SN74LV11A-Q1 TRIPLE 3-INPUT POSITIVE-AND GATE

SCES468C - JULY 2003 - REVISED APRIL 2005

- Qualification in Accordance With AEC-Q100†
- **Qualified for Automotive Applications**
- **Customer-Specific Configuration Control** Can Be Supported Along With Major-Change Approval
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- 2-V to 5.5-V V<sub>CC</sub> Operation
- Typical V<sub>OLP</sub> (Output Ground Bounce)  $< 0.8 \text{ V at V}_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)  $>2.3 \text{ V at V}_{CC} = 3.3 \text{ V, T}_{A} = 25^{\circ}\text{C}$

Support Mixed-Mode Voltage Operation on All Ports

Ioff Supports Partial-Power-Down Mode Operation



## description/ordering information

This triple 3-input positive-AND gate is designed for 2-V to 5.5-V V<sub>CC</sub> operation.

The SN74LV11A performs the Boolean function  $Y = A \bullet B \bullet C$  or  $Y = \overline{A} + \overline{B} + \overline{C}$  in positive logic.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### ORDERING INFORMATION

TA	PACKAGE <sup>‡</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 105°C	TSSOP - PW	Tape and reel	SN74LV11ATPWRQ1	LV11AT

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

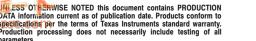
#### **FUNCTION TABLE** (each gate)

C.C.		TION TA	
	INPUTS	OUTPUT	
Α	В	С	Υ
Н	Н	Н	Н
L	X	X	L
Х	L	X	L
Х	X	L	L

logic diagram, each gate (positive logic)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





<sup>†</sup> Contact factory for details. Q100 qualification data available on request.

## SN74LV11A-Q1 TRIPLE 3-INPUT POSITIVE-AND GATE

SCES468C - JULY 2003 - REVISED APRIL 2005

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	. $-0.5 \text{ V}$ to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	. $$ –0.5 V to 7 V
Output voltage range applied in high or low state, VO (see Notes 1 and 2)0.5 V	' to V <sub>CC</sub> + 0.5 V
Voltage range applied to any output in the power-off state, V <sub>O</sub> (see Note 1)	. $$ –0.5 V to 7 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±25 mA
Continuous current through V <sub>CC</sub> or GND	±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3)	113°C/W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. This value is limited to 5.5 V maximum.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 4)

			MIN	MAX	UNIT		
Vcc	Supply voltage		2	5.5	V		
		V <sub>CC</sub> = 2 V	1.5				
.,	I Pale Level Page of coality as	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V <sub>CC</sub> ×0.7				
VIH	High-level input voltage	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$	$V_{CC} \times 0.7$		V		
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	$V_{CC} \times 0.7$				
		V <sub>CC</sub> = 2 V		0.5			
.,	Law law Daniel and college	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V	CC × 0.3	.,		
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V	V	CC × 0.3	V		
		V <sub>CC</sub> = 4.5 V to 5.5 V	V	CC × 0.3			
٧ı	Input voltage		0	5.5	V		
Vo	Output voltage		0	Vcc	V		
		V <sub>CC</sub> = 2 V		-50	μΑ		
	I Pale Javel and and annual	V <sub>CC</sub> = 2.3 V to 2.7 V	-2				
ІОН	High-level output current	V <sub>CC</sub> = 3 V to 3.6 V		-6	mA		
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-12			
		V <sub>CC</sub> = 2 V		50	μΑ		
	Law law Law tast sums at	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2				
loL	Low-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		6	mA		
		V <sub>CC</sub> = 4.5 V to 5.5 V		12	1		
		V <sub>CC</sub> = 2.3 V to 2.7 V		200			
Δt/Δν	Input transition rise or fall rate	V <sub>CC</sub> = 3 V to 3.6 V		100	ns/V		
		V <sub>CC</sub> = 4.5 V to 5.5 V		20			
TA	Operating free-air temperature		-40	105	°C		

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



## SN74LV11A-Q1 TRIPLE 3-INPUT POSITIVE-AND GATE

SCES468C - JULY 2003 - REVISED APRIL 2005

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	VCC	MIN	TYP MA	ΛX	UNIT		
	I <sub>OH</sub> = -50 μA	2 V to 5.5 V	V <sub>CC</sub> -0.1					
V	$I_{OH} = -2 \text{ mA}$	2.3 V	2			V		
VOH	$I_{OH} = -6 \text{ mA}$	3 V	2.48			V		
	$I_{OH} = -12 \text{ mA}$	4.5 V	3.8					
	$I_{OL} = 50 \mu\text{A}$	2 V to 5.5 V		C	.1			
.,	$I_{OL} = 2 \text{ mA}$	2.3 V		C	.4	] ,, ]		
VOL	$I_{OL} = 6 \text{ mA}$		0.	44	V			
	$I_{OL} = 12 \text{ mA}$	4.5 V		0.	55			
lį	$V_I = 5.5 \text{ V or GND}$	0 to 5.5 V		:	±1	μΑ		
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			20	μΑ		
l <sub>off</sub>	$V_I$ or $V_O = 0$ to 5.5 $V$	0 V			5	μΑ		
Ci	$V_I = V_{CC}$ or GND	3.3 V		1.9		рF		

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	T,	չ = 25°C	;	BAINI	BAAV	LINUT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
<sup>t</sup> pd	A, B, or C	Υ	C <sub>L</sub> = 50 pF		9.9	17.5	1	21	ns

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	T,	4 = 25°C	;		MAY	LINUT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
t <sub>pd</sub>	A, B, or C	Υ	C <sub>L</sub> = 50 pF		7.2	12.3	1	14	ns

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T	ղ = 25°C	;	BAINI	BAAV	LINUT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
t <sub>pd</sub>	A, B, or C	Υ	C <sub>L</sub> = 50 pF		5.4	7.9	1	9	ns



## SN74LV11A-Q1 TRIPLE 3-INPUT POSITIVE-AND GATE

SCES468C – JULY 2003 – REVISED APRIL 2005

## noise characteristics, $V_{CC}$ = 3.3 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 5)

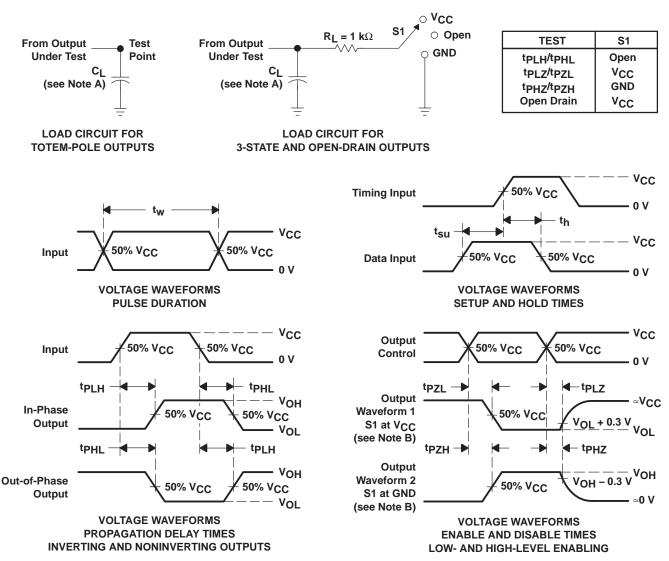
	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OL(P)</sub>	Quiet output, maximum dynamic V <sub>OL</sub>		0.2	0.8	V
V <sub>OL(V)</sub>	Quiet output, minimum dynamic VOL		0	-0.8	V
V <sub>OH(V)</sub>	Quiet output, minimum dynamic VOH		3.2		V
V <sub>IH(D)</sub>	High-level dynamic input voltage	2.31			V
V <sub>IL(D)</sub>	Low-level dynamic input voltage			0.99	V

NOTE 5: Characteristics are for surface-mount packages only.

## operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST COI	VCC	TYP	UNIT	
<u> </u>	Dougs dissination conscitons	C. F0 pF	f 40 MH-	3.3 V	13.9	۲
Cpd	Power dissipation capacitance	$C_L = 50 \text{ pF},$	f = 10 MHz	5 V	15.4	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_Q = 50 \Omega$ ,  $t_f \leq$  3 ns,  $t_f \leq$  3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms





### PACKAGE OPTION ADDENDUM

27-Jan-2006

### **PACKAGING INFORMATION**

Orderable De	evice Stat	tus <sup>(1)</sup> F	Package Type	Package Drawing	Pins P	ackage Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LV11ATP	WRQ1 AC	TIVE	TSSOP	PW	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

 $^{(1)}$  The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

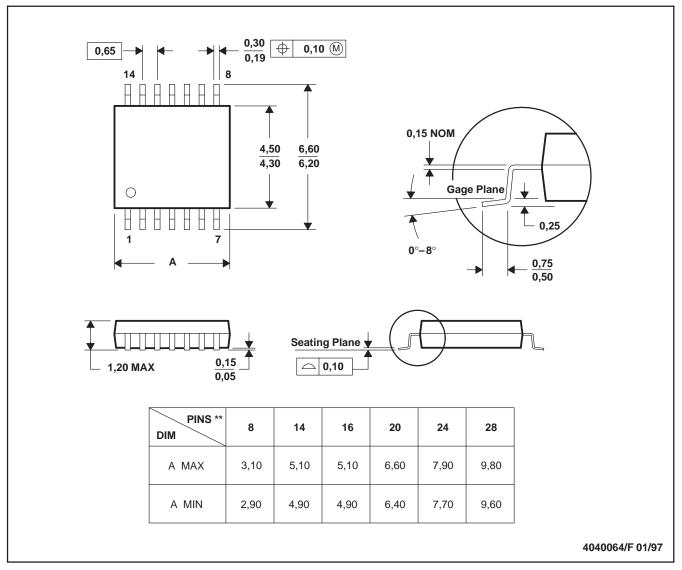
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## PW (R-PDSO-G\*\*)

### 14 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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